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Experimental and Numerical Study of Depositional Mechanism of Mudflow

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Mudflow in Nature



Viscoplastic Fluid

Experiments



de Haas et al. 2015

Scaling Runout



Dynamic Similarity



$$u = f(g, L, H, t, \theta, \rho, \underline{\sigma}, \mu, \tau_y)$$

stress

Dimensional analysis

$$\frac{u}{\sqrt{gL}} = \mathbf{F}\left(\frac{H}{L}, \frac{t}{\sqrt{L/g}}, \frac{\sigma}{\rho g H}, \frac{\mu}{\rho \sqrt{gH^3}}, \frac{\tau_y}{\rho g H}, \theta\right)$$
$$\frac{\mu}{Viscosity} \sim H^{3/2}, \ \frac{\tau_y}{Vield \ stress}$$

Strategy



Flume System



Front view

Side view

Cameras

Image Processing



Improved from Matlab Optical flow toolbox

Slurry Preparation





Kaolinate clay

Rheometer (R/S SST200 soft solid tester)

Rheometry



Viscoplastic models

$$\tau = \tau_{\nu} + \mu \dot{\gamma}$$

 $\tau = \tau_y + K \dot{\gamma}^n$

Bingham model

Herschel-Bulkley model

Numerical Scheme

Computational Fluid Dynamics (CFD) Free-surface Tracking: Volume of Fluid (VOF)



Validation (1)

CFD simulations

- Finite volume scheme

- Free surface tracked by VOF method

- non-Newtonian fluid model (Bingham, HB)



20% slurry

Validation (2)



Flow profile (depth)

Flow velocity at the front

Validation (3)



Final deposition: shape

Final deposition: depth

Deposit Morphology

Increasing viscosity



Increasing yield stress

Dynamic Similarity



 $\mu \sim H^{3/2}$ $\tau_y \sim H$

A Scaling Law



Future Work



Concentration: 21.1%; Viscosity: ~0.09Pa-s; Yield stress: 36.4Pa; Slope: 18 deg

Future Work



$$\tau_y = 40 \text{ Pa}, \mu = 0.05 \text{ Pa-s}; 2 \text{ s}$$

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Summary

Deposition of slurry relevant to natural mudflows:

- □ Fast runout and stoppage due to relatively low viscosity
- Elongated shape due to fast runout
- □ Remains stuck on the channel and steep edges due to high yield stress

A scaling law

- □ Has been tested from small-scale lab to large-scale simulation
- □ Incorporated with rheological parameters

Authors of this work: Jing L, Kwok CY, Leung, YF, Zhang Z, Dai L.